

Standard 25 A SCRs

Features

- On-state rms current, $I_{T(RMS)}$ 25 A
- Repetitive peak off-state voltage, V_{DRM}/V_{RRM} 600 to 800 V
- Triggering gate current, I_{GT} 40 mA
- Insulated package TO-220AB ins
 - Insulating voltage 2500 V rms
 - UL1557 certified (file ref. E81734)

Description

These standard 25 A SCRs are suitable for general purpose applications.

Using clip assembly technology, they provide a superior performance in surge current capabilities.

TXN625RG is packaged in TO-220AB ins.

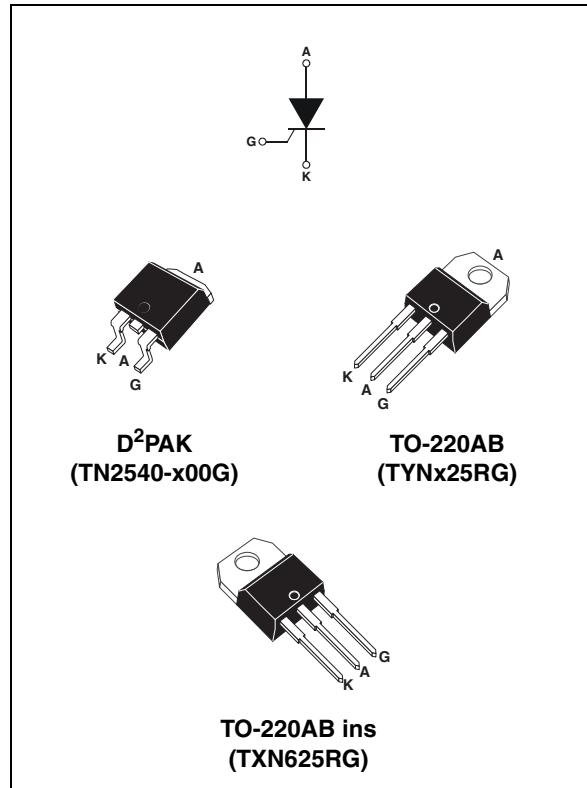


Table 1. Device summary

Order code	Voltage V_{DRM}/V_{RRM}		Sensitivity I_{GT}	Package
	600 V	800 V		
TN2540-600G-TR	Y		40 mA	D²PAK
TN2540-800G-TR		Y	40 mA	D²PAK
TXN625RG	Y		40 mA	TO-220AB ins
TYN625RG	Y		40 mA	TO-220AB
TYN825RG		Y	40 mA	TO-220AB

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	On-state rmscurrent (180 °Conduction angle)	TO-220AB, D ² PAK	$T_c = 100 \text{ }^\circ\text{C}$	25	A
		TO-220AB ins	$T_c = 83 \text{ }^\circ\text{C}$		
$I_{T(AV)}$	Average on-state current (180 °Conduction angle)		$T_c = 100 \text{ }^\circ\text{C}$	16	A
I_{TSM}	Non repetitive surge peak on-state current	$t_p = 8.3 \text{ ms}$	$T_j = 25 \text{ }^\circ\text{C}$	314	A
		$t_p = 10 \text{ ms}$		300	
I^2t	I^2t Value for fusing	$t_p = 10 \text{ ms}$	$T_j = 25 \text{ }^\circ\text{C}$	450	A^2s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}, t_r \leq 100 \text{ ns}$	$F = 60 \text{ Hz}$	$T_j = 125 \text{ }^\circ\text{C}$	50	$\text{A}/\mu\text{s}$
I_{GM}	Peak gate current	$t_p = 20 \mu\text{s}$	$T_j = 125 \text{ }^\circ\text{C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125 \text{ }^\circ\text{C}$	1	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	$^\circ\text{C}$
V_{RGM}	Maximum peak reverse gate voltage			5	V

Table 3. Electrical Characteristics ($T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified)

Symbol	Test conditions		Value	Unit	
I_{GT}	$V_D = 12 \text{ V}$	$R_L = 33 \Omega$	MIN.	4	
			MAX.	40	
V_{GT}			MAX.	1.3	
V_{GD}	$V_D = V_{DRM}$	$R_L = 3.3 \text{ k}\Omega$	$T_j = 125 \text{ }^\circ\text{C}$	MIN.	V
I_H	$I_T = 500 \text{ mA}$ Gate open		MAX.	50	mA
I_L	$I_G = 1.2 \times I_{GT}$		MAX.	90	mA
dV/dt	$V_D = 67 \% V_{DRM}$ Gate open		$T_j = 125 \text{ }^\circ\text{C}$	MIN.	$\text{V}/\mu\text{s}$
V_{TM}	$I_{TM} = 50 \text{ A}$ $t_p = 380 \mu\text{s}$		$T_j = 25 \text{ }^\circ\text{C}$	MAX.	V
V_{t0}	Threshold voltage		$T_j = 125 \text{ }^\circ\text{C}$	MAX.	0.77
R_d	Dynamic resistance		$T_j = 125 \text{ }^\circ\text{C}$	MAX.	$\text{m}\Omega$
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM}$	$T_j = 25 \text{ }^\circ\text{C}$	MAX.	5	μA
		$T_j = 125 \text{ }^\circ\text{C}$		4	mA

Table 4. Thermal resistances

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case (DC)	1.0	$^{\circ}\text{C}/\text{W}$
	TO-220AB ins	2.0	
$R_{th(j-a)}$	Junction to ambient (DC) $S^{(1)} = 1 \text{ cm}^2$	D ² PAK	45
		TO-220AB, TO-220AB ins	60

1. S = Copper surface under tab.

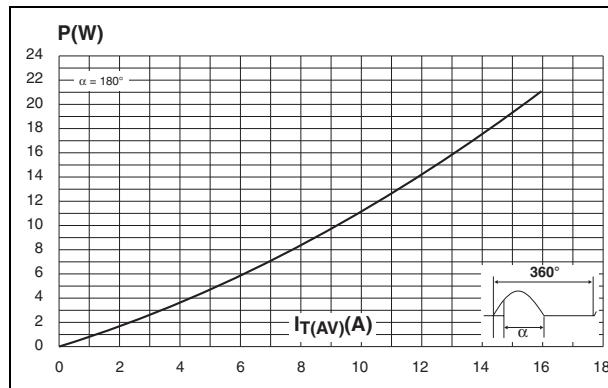
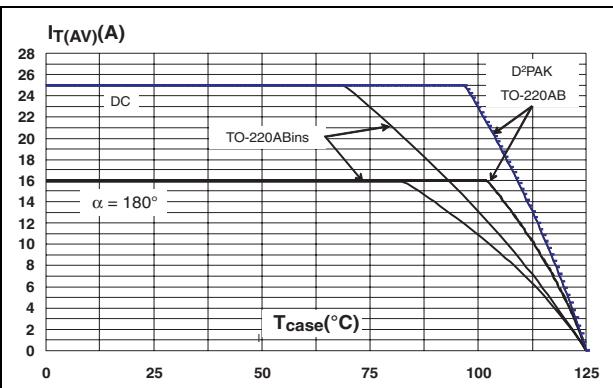
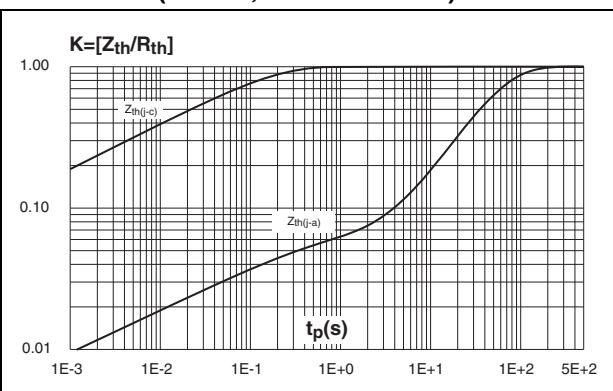
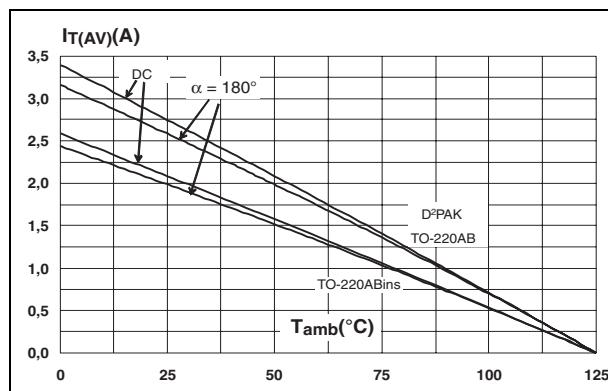
Figure 1. Maximum average power dissipation versus average on-state current**Figure 3. Average and DC on-state current versus ambient temperature****Figure 2. Average and DC on-state current versus case temperature****Figure 4. Relative variation of thermal impedance versus pulse duration (D²PAK, and TO-220AB)**

Figure 5. Relative variation of thermal impedance versus pulse duration (TO-220AB ins)

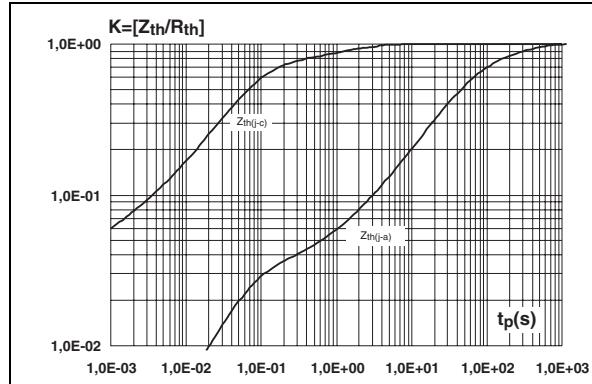


Figure 6. Relative variation of gate trigger, holding, and latching currents versus junction temperature

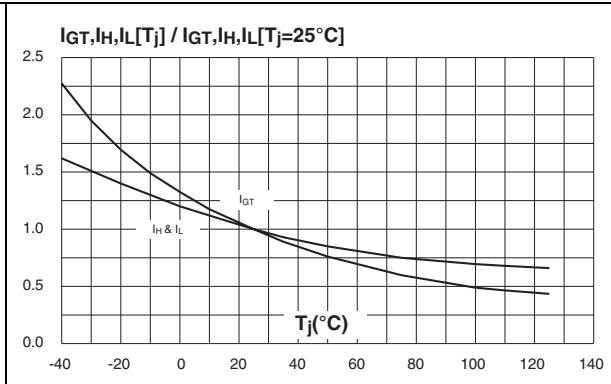


Figure 7. Surge peak on-state current versus number of cycles

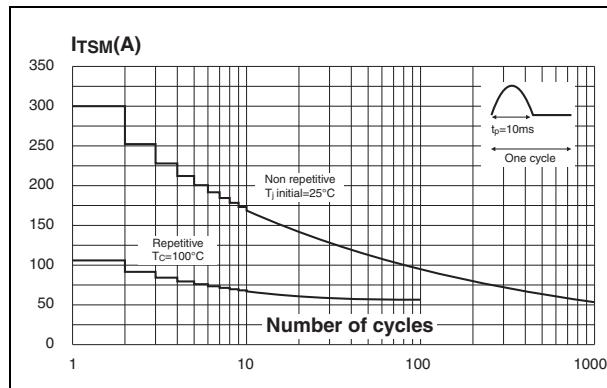


Figure 8. Non-repetitive surge peak on-state current, and corresponding values of I^2t

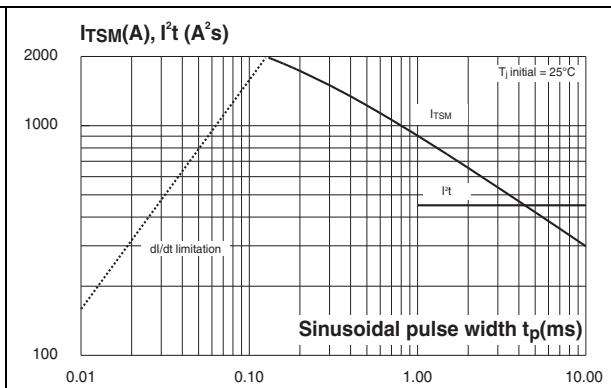


Figure 9. On-state characteristics (maximum values)

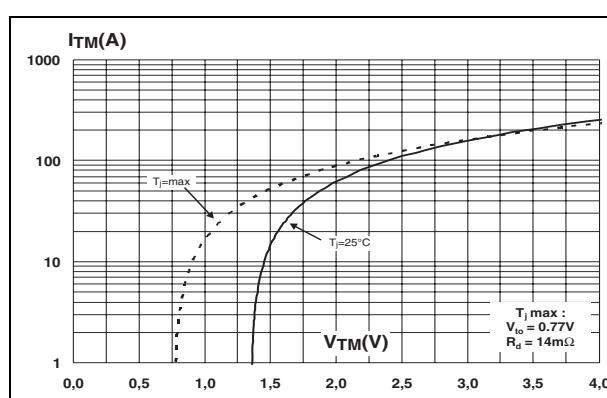
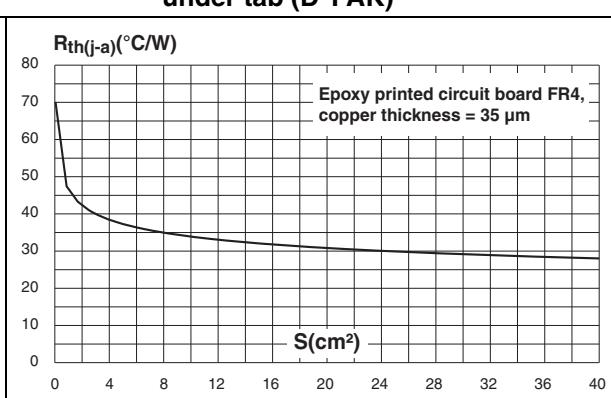


Figure 10. Thermal resistance junction to ambient versus copper surface under tab (D²PAK)



2 Ordering information schemes

Figure 11. TN2540-x00G ordering information scheme

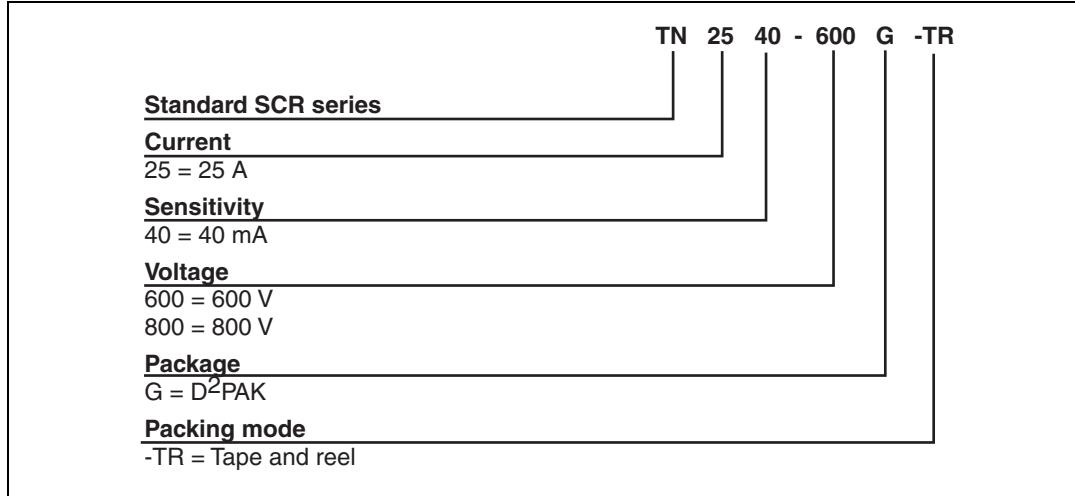


Figure 12. TXN625RG ordering information scheme

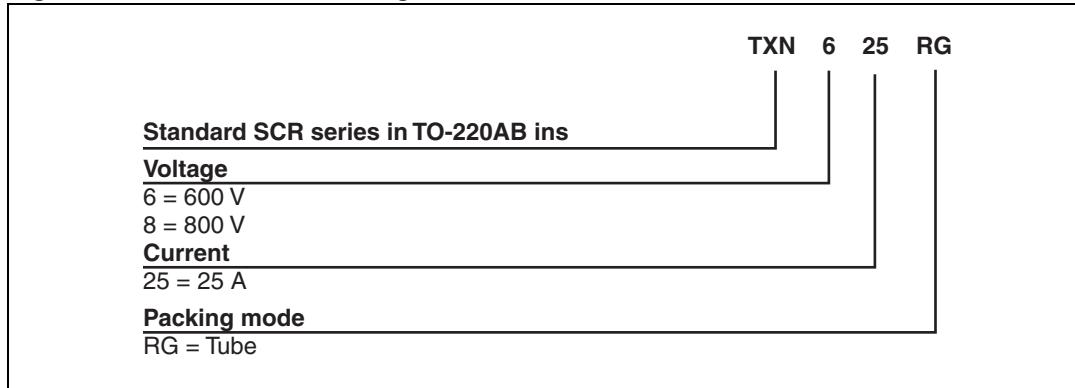
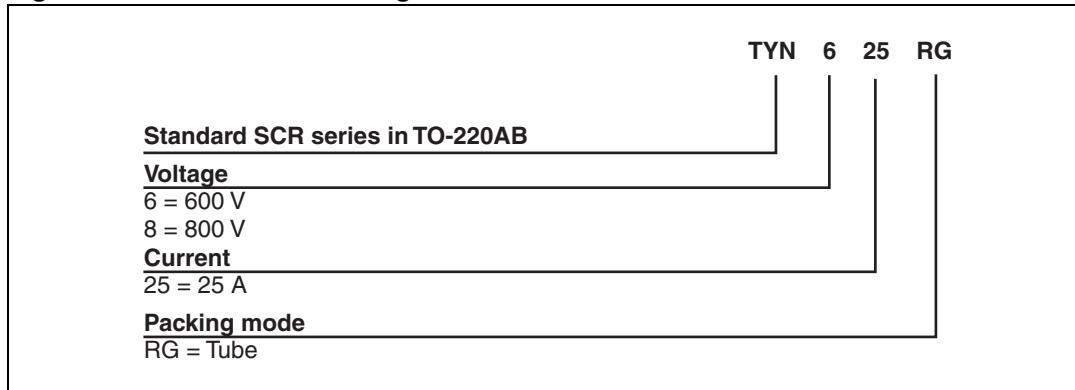


Figure 13. TYNx25RG ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Recommended torque values (TO-220AB, and TO220AB ins): 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Table 5. D²PAK dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.30		4.60	0.169		0.181
A1	2.49		2.69	0.098		0.106
A2	0.03		0.23	0.001		0.009
B	0.70		0.93	0.027		0.037
B2	1.25	1.40		0.048	0.055	
C	0.45		0.60	0.017		0.024
C2	1.21		1.36	0.047		0.054
D	8.95		9.35	0.352		0.368
E	10.00		10.28	0.393		0.405
G	4.88		5.28	0.192		0.208
L	15.00		15.85	0.590		0.624
L2	1.27		1.40	0.050		0.055
L3	1.40		1.75	0.055		0.069
R	0.40			0.016		
V2	0°		8°	0°		8°

Figure 14. D²PAK footprint (dimensions in mm)

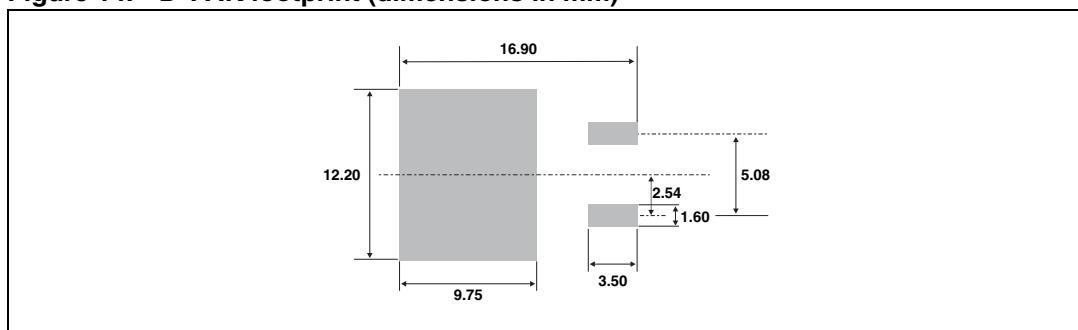
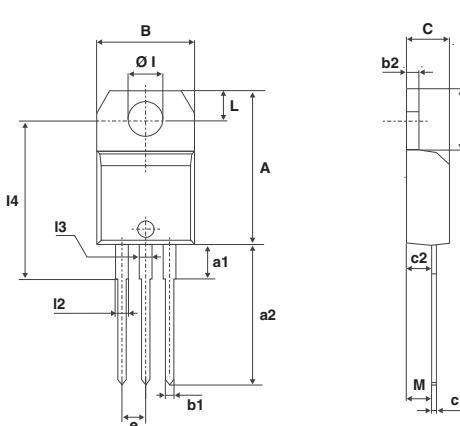


Table 6. TO-220AB dimensions

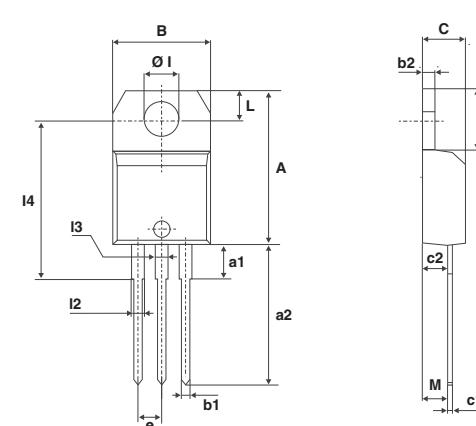
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
Øl	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	



The technical drawing illustrates the TO-220AB package in two views. The top view shows the package from above with dimensions A (height), B (width), C (depth), and various lead and body dimensions labeled with lowercase letters (a1, a2, b1, b2, c1, c2, e, F, l1, l2, l3, l4). The side cross-section shows the height of the lead assembly (M) and the distance from the base to the lead tip (c1).

Table 7. TO-220AB ins dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.20		15.90	0.598		0.625
a1		3.75			0.147	
a2	13.00		14.00	0.511		0.551
B	10.00		10.40	0.393		0.409
b1	0.61		0.88	0.024		0.034
b2	1.23		1.32	0.048		0.051
C	4.40		4.60	0.173		0.181
c1	0.49		0.70	0.019		0.027
c2	2.40		2.72	0.094		0.107
e	2.40		2.70	0.094		0.106
F	6.20		6.60	0.244		0.259
Øl	3.75		3.85	0.147		0.151
I4	15.80	16.40	16.80	0.622	0.646	0.661
L	2.65		2.95	0.104		0.116
I2	1.14		1.70	0.044		0.066
I3	1.14		1.70	0.044		0.066
M		2.60			0.102	



The technical drawing illustrates the TO-220AB package in two views. The left view shows the top surface with dimensions A (height), L (width), B (depth), and various lead-related dimensions like I4, I3, I2, and e. The right view shows a vertical cross-section with dimensions c (width), b2 (lead thickness), F (lead height), c1 (lead gap), c2 (lead gap), and M (lead pitch). The central part of the drawing shows the internal structure with lead positions and a central hole Øl.

4 Ordering information

Table 8. Ordering information

Order code	Voltage	Sensitivity	Marking	Package	Weight	Base qty	Delivery mode
TN2540-600G-TR	600 V	40 mA	TN2540600G	D ² PAK	1.5 g	1000	Tape & reel
TN2540-800G-TR	800 V	40 mA	TN2540800G	D ² PAK	1.5 g	1000	Tape & reel
TXN625RG	600 V	40 mA	TXN625	TO-220AB ins	2.3 g	50	Tube
TYN625RG	600 V	40 mA	TYN625	TO-220AB	2.3 g	50	Tube
TYN825RG	800 V	40 mA	TYN825	TO-220AB	2.3 g	50	Tube

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
Apr-2002	4A	Previous update
13-Feb-2006	5	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.
17-Jun-2011	6	Added TXN625.
13-Sep-2011	7	Added UL certification in <i>Features</i> .

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